Multi standard quasi parallel-sound processor for TV-sets

Technology: Bipolar

Features

- High signal sensitivity
- Simple filter configuration and few external components
- Processing of two carrier stereo signals
- Low intercarrier distortions

- ESD protected
- Alignment free AM demodulator for the standard L
- VCO controlled mixer stage converts intercarrier frequencies of different standards into a preferred sound IF
- Optimum tuning characteristic

Case: 20-pin dual inline plastic

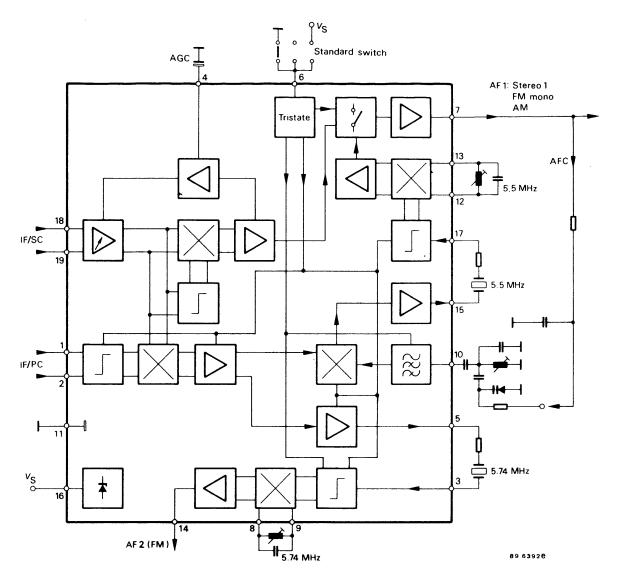


Figure 1 Block diagram

Pin Configuration

Pin	Symbol	Function				
1–2		Vision-IF-carrier input				
3		Intercarrier input 5.74 MHz				
4		AGC time constant				
5		Intercarrier output 5.74 MHz				
6		Standard switch				
7		AF output 1				
8-9		Phase tank circuit 5.74 MHz				
10		VC0 tank circuit				

Pin	Symbol	Function
11		Ground
12-13		Phase tank circuit 5.5 MHz
14		AF output 2
15		Intercarrier output 5.5 MHz
16		Supply voltage
17		Intercarrier input 5.5 MHz
18-19		Sound-IF-carrier input
20		n.c.

Circuit Description

The integrated circuit allows the high quality processing of sound carrier for different TV standards. The circuit requires separate vision and audio carrier inputs. It delivers the output audio signal for mono, two channels or stereo applications.

Audio carrier signal (simple or double carrier, FM and AM) is applied via three stage AGC controlled broad band amplifier which delivers regulated output signal for two mixing stages. One mixer works for AM-demodulation and AGC-function whereas the second mixer produces the sound intercarrier IF-frequencies (5.5/5.74 MHz).

Vision carrier signal for the intercarrier generation is delivered from the demodulator tank of the video IF circuit (TDA 4439, TDA 4453). It is then matched via a limiter stage to the FM intercarrier mixer. FM-sound-IF-carrier reaches the quadrature demodulator via the selection circuit and the following limiter amplifier. The final audio signal is supplied to the low ohmic output (Pin 7,14) with low pass filter character.

There is a switchable converter for different audio standards (4.5, 6.00 and 6.5 MHZ), which mixes the sound 1P-signal properly e.g. at 5.5 MHz. The VC0 (Pin 10) must be controlled across the sound output (Pin 7) which includes AFC-function.

Sound signal at the AM-modulation is introduced via standard switch in the first sound channel, whereas the intercarrier, converter section and both FM demodulators are switched off. In case of sound IF converter operation, the second sound channel and the AM-section are switched off. The standard mode is controlled by a tristate signal on Pin 6.

Absolute Maximum Ratings

Reference point Pin 11, unless otherwise specified

	Parameters	Symbol	Value	Unit
Supply voltage	Pin 16	V_{S}	10 to 13.5	V
Supply current	Pin 16	I_S	80	mA
External voltage	Pin 6 Pin 1, 2, 3, 4, 5, 7, 8, 9, 12,	V _{ext}	V_{S}	V
	13, 14, 15, 17, 18, 19	V _{ext}	6	V
Power dissipation				
(in soldered position)		P _{tot}	1	W
Junction temperature		T_{j}	125	°C
Ambient temperature r	ange	T _{amb}	- 25 to + 70	°C
Storage temperature ra	nge	T _{stg}	- 25 to + 125	°C

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Thermal Resistance

Parameters	Symbol	Value	Unit
Junction ambient	R_{thJA}	60	K/W

Electrical Characteristics

 V_5 = 12 V, T_{amb} = 25 $^{\circ}$ C, reference point pin 11, f_{PC} = 38.9 MHz, f_{SC1} = 33.4 MHz, f_{SC2} = 33.1578 MHz, SC1/SC2 = -7 dB, unless otherwise specified

Parameters	Test Conditio	ns / Pin	Symbol	Min	Type	Max	Unit
Supply voltage range		Pin 16	V_{S}	10		13.5	V
Supply current	FM-operation, AM-operation,	Pin 16 Pin 16	$I_{ m S}$ $I_{ m S}$		65 40		mA mA
Output DC voltage		Pin 7,14	V_0		3.5		V
Standard switching voltage	Standard B/G, Standard L, converter operation	Pin 6 Pin 6 on Pin 6	V V V	1.7 0 3.5	2.2	2.7 1.5 V _S	V V V
Standard switching current	$V_6 \le 5 \text{ V}$	Pin 6	I			20	μΑ
Picture carrier input voltage		Pin 1,2	v	5	10	20	mV
Min. sound carrier input voltage SC1	5.5 MHz-output signal –3 dB	Pin 18,19	V		50		μV
Max. sound carrier input voltage SC1		Pin 18,19	v		100		mV
AGC range					65		dB
Audio output voltage	FM-deviation = 3 m = 80 %	0 kHz Pin 7,14	v		500		mV _{eff}
Audio voltage difference between both outputs		Pin 7,14	v			±1	dB
Harmonic distortion AM- operation	$f_{\text{mod}} = 1 \text{ kHz},$ FM-deviation = 3	Pin 7,14 0 kHz	d		0.5		%
Harmonic distortion AM- operation	f _{mod} = 1 kHz, m = 80 %, v ₁₈₋₁₉	Pin 7 = 10 mV	d		1.5	3.0	%
Min. output load		Pin 7,14	R	3			kΩ
Signal to noise ratio (Standar CCIR 468-2 specifications, S PC: $v_{1-2} = 10$ mV, prelimited signal from TDA 4453 refere FM deviation = 30 kHz	C1: v ₁₈₋₁₉ = 10 mV demodulator pictur	y, re carrier					
Black burst 1. channel 12. channel 12.		Pin 7/14	(S=N)/N		62/60		dB
Grid test signal 1. channel/2. channel 1)		Pin 7/14	(S=N)/N		50/48		dB
Converter	•				•	•	•
DC voltage	$V_6 \ge 3.5 \text{ V}$	Pin 10	V ₁₀		2.7		V
Tuning range		Pin 10	f	9		13	MHz
Input resistance		Pin 10	R		100		kΩ
Input capacity		Pin 10	С		12		pF

Parameters	Test Condit	ions / Pin	Symbol	Min	Type	Max	Unit	
Signal to noise ratio (Standard CCIR 468-2 specifications, SO PC: $v_{1-2} = 10$ mV, prelimited signal from TDA 4453 reference FM deviation = 30 kHz								
Black burst 1. channel/2. channel 1)		Pin 7/14	(S=N)/N		62/60		dB	
Grid test signal 1. channel/2. channel 1)		Pin 7/14	(S=N)/N		50/48		dB	
Converter								
DC voltage	$V_6 \ge 3.5 \text{ V}$	Pin 10	V ₁₀		2.7		V	
Tuning range		Pin 10	f	9		13	MHz	
Input resistance		Pin 10	R		100		kΩ	
Input capacity		Pin 10	C		12		pF	

¹⁾ Standard B/G IF-modulated FBAS-signal

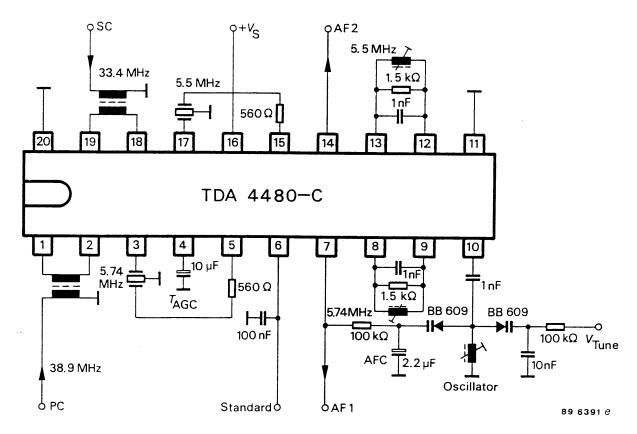
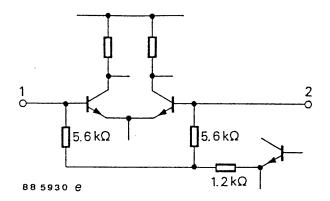
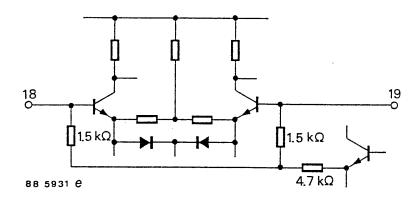


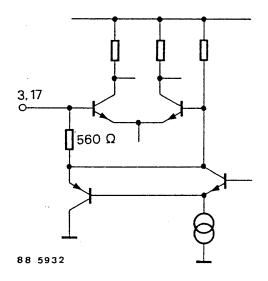
Figure 2: Test circuit



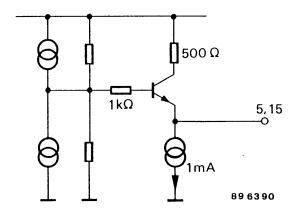
Pin 1,2 IF-input vision carrier



Pin 18,19
IF-input sound carrier

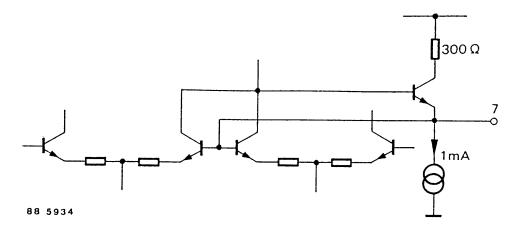


Pin 3 (17) Intercarrier input Pin 3: 5.74 MHz Pin 17: 5.5 MHz

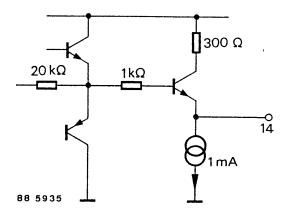


Pin 5 (15)

Intercarrier output Pin 5: 5.74 MHz Pin 15: 5.5 MHz

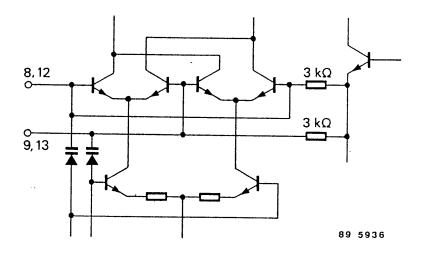


Pin 7
AP-output AM/PM (channel 1, 5.5 MHz)



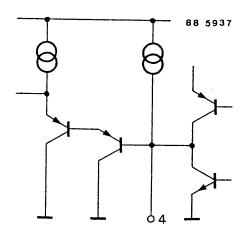
Pin 14
AF-output FM

(channel 2, 5.74 MHz)



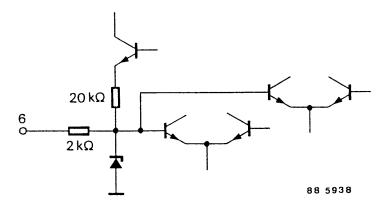
Pin 8,9 (12,13)

Phase tank circuit Pin 8, 9:5.74 MHz Pin 12,13:5.5 MHz



Pin 4

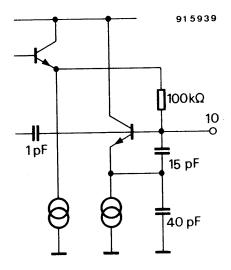
AGC time constant



Pin 6

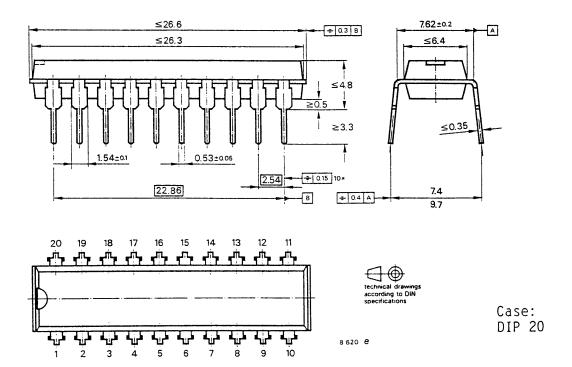
Standard switch

TDA 4480-C



Pin 10 VC0 tank circuit

Dimensions in mm



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OZONE DEPLETING SUBSTANCES POLICY STATEMENT

It is the policy of TEMIC TELEFUNKEN microelectronic GmbH to

- 1. Meet all present and future national and international statutory requirements and
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

Of particular concern is the control or elimination of releases into the atmosphere of those substances which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) will soon severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

TEMIC TELEFUNKEN microelectronic GmbH semiconductor division has been able to use its policy of continuous improvements to eliminate the use of any ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA and
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

TEMIC can certify that our semiconductors are not manufactured with and do not contain ozone depleting substances.

We reserve the right to make changes to improve technical design without further notice.

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